

VMDSEMI

**VUSK002R25ANA**

**Datasheet**

## General Description

## Symbol

$V_{(BR)DSS}$	$R_{DS(ON)_{max}}$	$I_D$
20V	250mΩ@4.5V	0.5A
	340mΩ@2.5V	

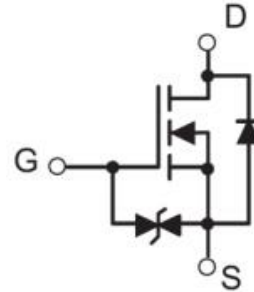
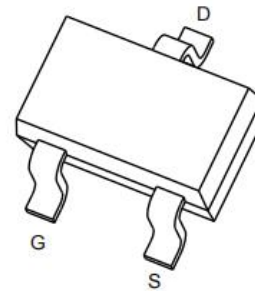


Figure 1 Symbol of VUSK002R25ANA

## Features

- Excellent  $R_{DS(on)}$  and Low Gate Charge
- Low threshold
- Fast Switching Speed
- ESD Protected

## Package Type



### SOT-523

## Application

- DC/DC Converter
- Load Switch for Portable Devices
- Battery Operated Systems

Figure 2 Package Type of VUSK002R25ANA

## Ordering Information

Product Name	Package
VUSK002R25ANA	SOT-523

**Absolute Maximum Ratings** ( $T_A = 25\text{ °C}$ , unless otherwise specified)

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	$V_{DSS}$	20	V
Gate-Source Voltage	$V_{GSS}$	$\pm 12$	V
Continuous Drain Current <sup>Note1</sup>	$I_D$	0.5	A
Pulsed Drain Current ( $t=300\mu s$ ) <sup>Note2</sup>	$I_{DM}$	1.0	A
Total Power Dissipation <sup>Note4</sup> $T_A = 25\text{ °C}$	$P_D$	0.15	W
Total Power Dissipation <sup>Note4</sup> $T_C = 25\text{ °C}$	$P_D$	0.275	W
Junction Temperature	$T_J$	150	°C
Storage Temperature	$T_{STG}$	-55 to 150	°C

**Thermal Resistance**

Parameter	Symbol	Min	Typ	Max	Unit
Thermal Resistance, Junction-to-Ambient <sup>Note5</sup>	$R_{\theta JA}$		653		°C/W

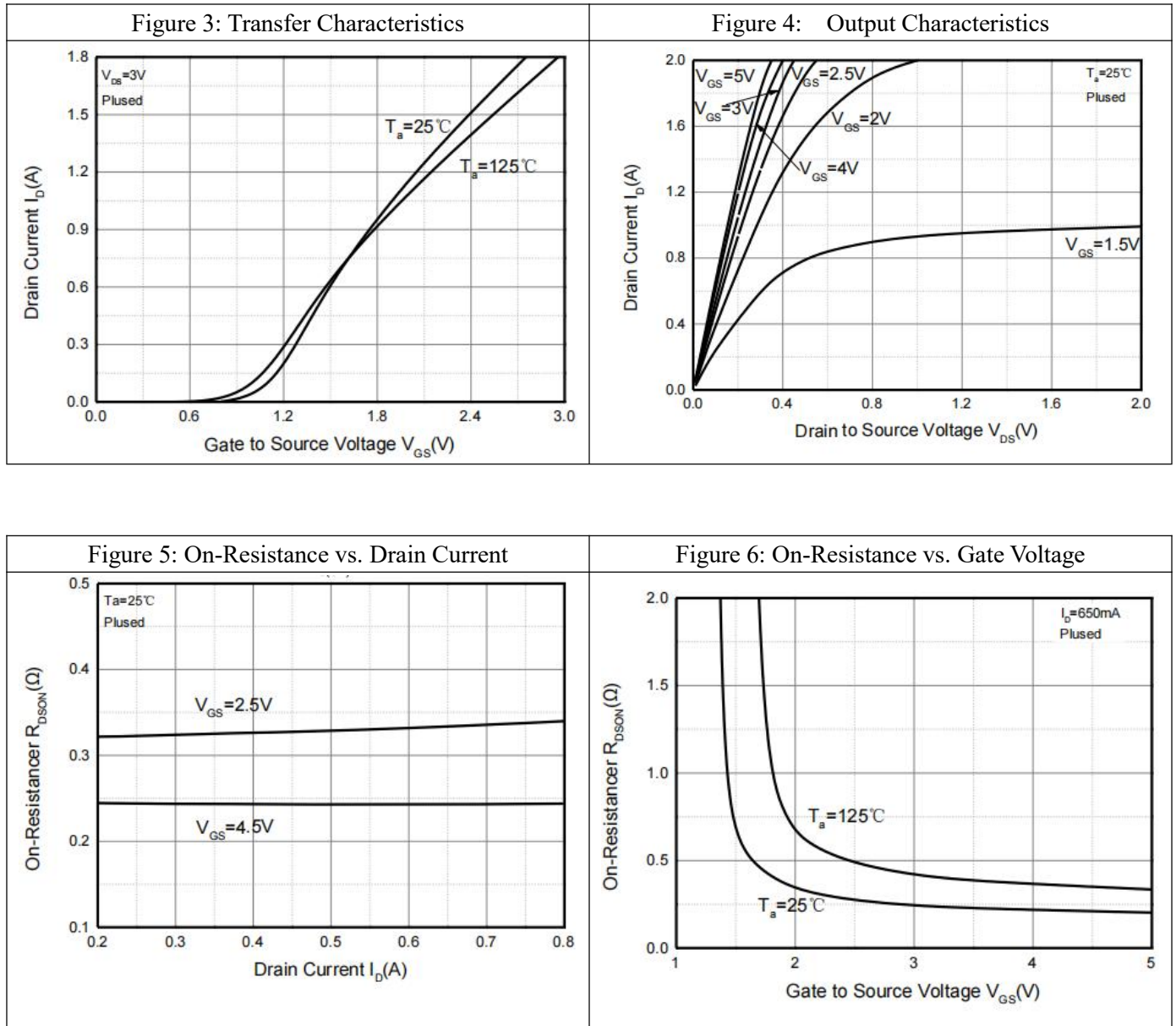
**Electrical Characteristics** ( $T_A = 25\text{ }^\circ\text{C}$ , unless otherwise specified)

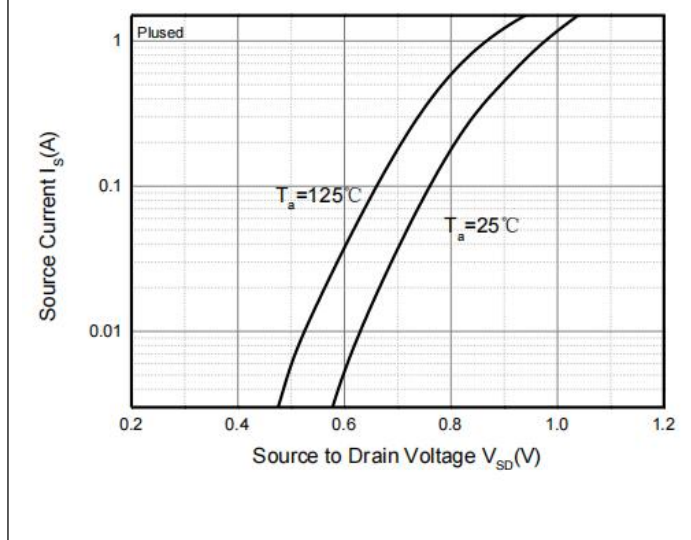
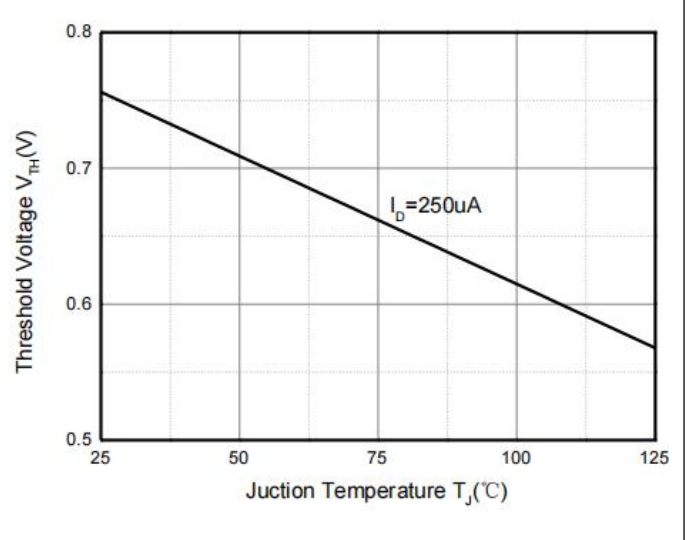
Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
<b>Statistic Characteristics</b>						
Drain-Source Breakdown Voltage	$BV_{DSS}$	$V_{GS}=0V, I_D=250\mu A$	20			V
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS}=16V, V_{GS}=0V$			1	$\mu A$
Gate-Body Leakage Current	$I_{GSS}$	$V_{GS} = \pm 4.5V, V_{DS}=0V$			$\pm 1$	$\mu A$
Gate Threshold Voltage <sup>Note3</sup>	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	0.45	0.8	1.2	V
Drain-source on-resistance <sup>Note3</sup>	$R_{DS(on)}$	$V_{GS}=4.5V, I_D=0.6A$		190	250	
		$V_{GS}=2.5V, I_D=0.5A$		260	340	
Forward transconductance <sup>Note3</sup>	$g_{FS}$	$V_{DS}=10V, I_D=0.4A$		1.1		S
<b>Dynamic Characteristics</b>						
Input Capacitance	$C_{ISS}$	$V_{DS}=16V$			120	pF
Output Capacitance	$C_{OSS}$	$V_{GS}=0V$			20	pF
Reverse Transfer Capacitance	$C_{RSS}$	$f=1MHz$			15	pF
<b>Switching Parameters</b>						
Turn-on Delay Time	$t_{d(on)}$	$V_{DD}=10V$		6.7		ns
Turn-on Rise Time	$t_r$	$V_{GEN}=4.5V$		4.8		
Turn-off Delay Time	$t_{d(off)}$	$I_D=0.5A$		17.3		
Turn-off Fall Time	$t_f$	$R_{GEN}=10\Omega$		7.4		
<b>Diode Characteristics</b>						
Diode Forward Voltage <sup>Note3</sup>	$V_{SD}$	$V_{GS}=0V, I_S=0.15A$			1.2	V

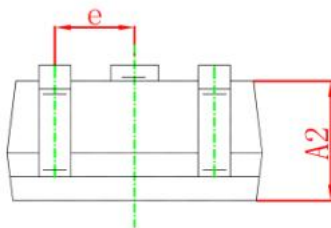
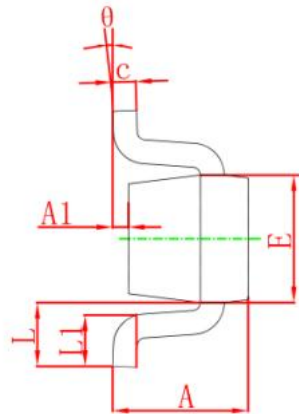
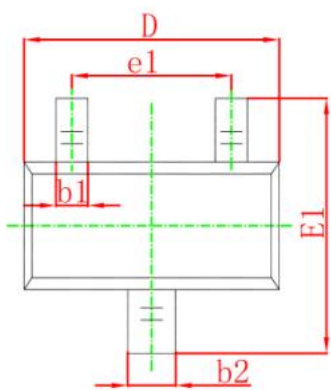
Notes :

- 1.The maximum current rating is limited by package.
- 2.Pulse Test : Pulse Width  $\leq 10\mu s$ , duty cycle  $\leq 1\%$ .
- 3.Pulse Test : Pulse Width  $\leq 300\mu s$ , duty cycle  $\leq 2\%$ .
- 4.The power dissipation  $P_D$  is limited by  $T_{J(MAX)} = 150^\circ\text{C}$ .
- 5.Device mounted on  $1in^2$  FR-4 board with 2oz. Copper, in a still air environment with  $T_A=25^\circ\text{C}$ .

## Typical Performance Characteristics



**Figure 7: Body Diode Characteristics**

**Figure 8: Threshold Voltage**


**Mechanical Dimensions:**
**SOT-523 Package Information**


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.700	0.900	0.028	0.035
A1	0.000	0.100	0.000	0.004
A2	0.700	0.800	0.028	0.031
b1	0.150	0.250	0.006	0.010
b2	0.250	0.350	0.010	0.014
c	0.100	0.200	0.004	0.008
D	1.500	1.700	0.059	0.067
E	0.700	0.900	0.028	0.035
E1	1.450	1.750	0.057	0.069
e	0.500 TYP.		0.020 TYP.	
e1	0.900	1.100	0.035	0.043
L	0.400 REF.		0.016 REF.	
L1	0.260	0.460	0.010	0.018
θ	0°	8°	0°	8°

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